

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/530,343	Confirmation No. :	7755
First Named Inventor	:	Ralf LERNER, et al.		
Filed	:	April 6, 2005		
TC/A.U.	:	2823		
Examiner	:	William D. Coleman		
Docket No.	:	60291.000034		
Customer No.	:	21967		
Title	:	TRENCH INSULATION IN SUBSTRATE DISKS COMPRISING LOGIC SEMICONDUCTORS AND POWER SEMICONDUCTORS		

AMENDMENT UNDER 37 C.F.R. § 1.312

MAIL STOP ISSUE FEE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. § 1.312, Applicants submit the following Amendments.

Applicants respectfully request that the application be amended as set forth herein. The amendment is to expedite grant and does not introduce new issues.

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.